



**BRIGHTTEK**  
**BRIGHTTEK (EUROPE) LIMITED**

*Brighten Up The World With LED!*



ISO/TS 16949:2009



BS EN ISO 14001:2004



QC 080000 IECQ HSPM

## PRODUCT DATASHEET

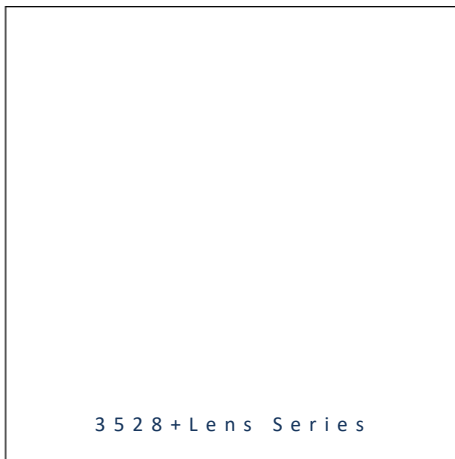


- ▶ PLCC2 Top View
- ▶ 3528+Lens Series
- ▶ Green (520nm)

**NOG51S32BS**



Release Date: 30 April 2020 Version: A1.0



3528+Lens Series

### 3528+Lens Series

**RoHS**  
Compliant



#### FEATURES:

- **Package:** PLCC2 Black Face SMT Package with Lens
- **Forward Current:** 50mA
- **Forward Voltage (typ.):** 3.1V
- **Luminous Intensity (typ.):** 20000mcd@50mA
- **Colour:** Green
- **Wavelength:** 520nm
- **Viewing angle:** 30°
- **Materials:**
  - Die: InGaN
  - Resin: Epoxy (Water Clear)
  - L/F Finish: Ag Plated
- **Operating Temperature:** -40~+80°C
- **Storage Temperature:** -40~+85°C
- **Grouping parameters:**
  - Forward voltage
  - Luminous intensity
  - Dominant Wavelength
- **Soldering methods:** Reflow soldering
- **Preconditioning:** acc. to JEDEC Level 3
- **Packing:** 12mm tape with max.2000pcs/reel, ø330mm (13'')

#### APPLICATIONS:

- LED Display
- Indicator
- Traffic Display
- Decoration Lighting

## CHARACTERISTICS:

### Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I <sub>F</sub>	70	mA
Peak Forward Current Duty 1/8@1KHz	I <sub>FP</sub>	125	mA
Reverse Voltage	V <sub>R</sub>	5	V
Reverse Current @5V	I <sub>R</sub>	10	μA
Power Dissipation	P <sub>D</sub>	259	mW
Operating Temperature	T <sub>OPR</sub>	-40~+80	°C
Storage Temperature	T <sub>STG</sub>	-40~+85	°C

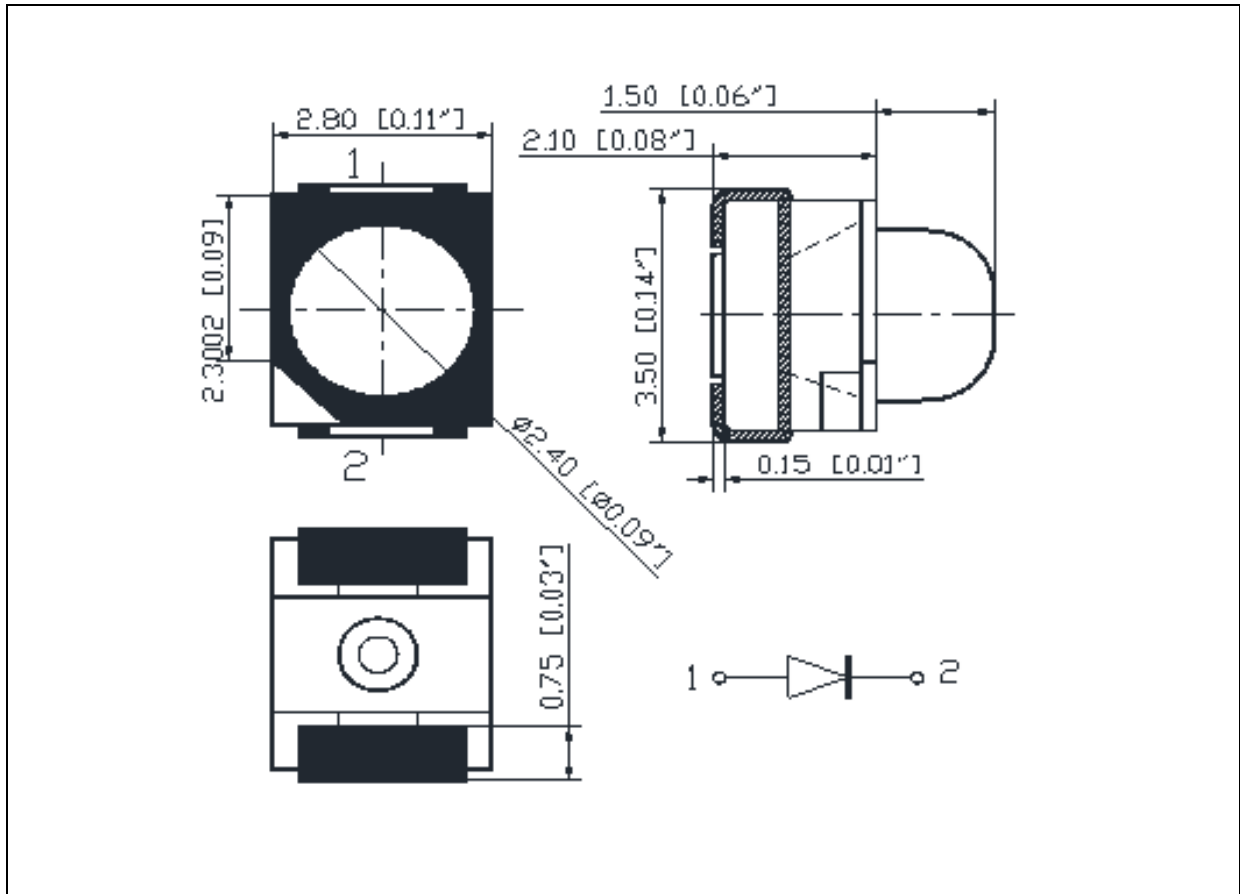
### Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test Condition
		Min.	Typ.	Max.		
Forward Voltage	V <sub>F</sub>	2.8	3.1	3.7	V	I <sub>F</sub> =50mA
Luminous Intensity	I <sub>v</sub>	11200	20000	36000	mcd	I <sub>F</sub> =50mA
Dominant Wavelength	λ <sub>D</sub>	515	520	525	nm	I <sub>F</sub> =50mA
Peak Wavelength	λ <sub>P</sub>	---	515	---	nm	I <sub>F</sub> =50mA
Spectral Half Bandwidth	Δλ	---	31	---	nm	I <sub>F</sub> =50mA
Viewing Angle	2θ <sub>1/2</sub>	---	30	---	deg	I <sub>F</sub> =50mA

1. Luminous intensity (I<sub>v</sub>) ±15%, Forward Voltage (V<sub>F</sub>) ±0.1V, Viewing angle(2θ<sub>1/2</sub>) ±5%

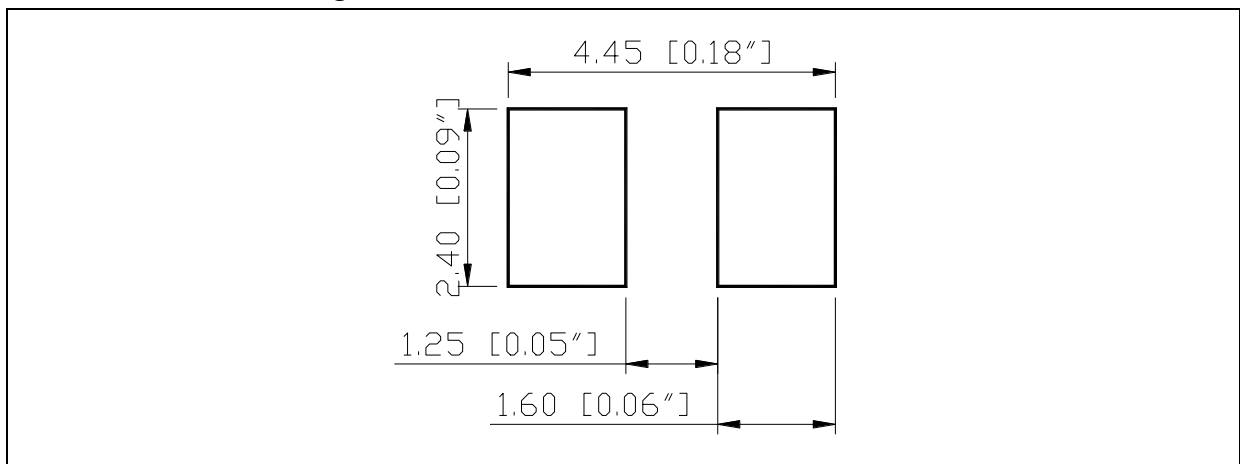
## OUTLINE DIMENSION:

Package Dimension:



1. All dimensions are in millimetre (mm).
2. Tolerance  $\pm 0.2\text{mm}$ , unless otherwise noted.

Recommended Soldering Pad Dimension:



1. Dimensions are in millimetre (mm).
2. Tolerance  $\pm 0.1\text{mm}$  with angle tolerance  $\pm 0.5^\circ$ .

**BINNING GROUPS:**


---

 Forward Voltage Classifications ( $I_F = 50\text{mA}$ ):

Code	Min.	Max.	Unit
f	2.8	3.1	V
g	3.1	3.4	
h	3.4	3.7	

 Luminous Intensity Classifications ( $I_F = 50\text{mA}$ ):

Code	Min.	Max.	Unit
d	11200	14200	mcd
e	14200	18000	
f	18000	22500	
g	22500	28500	
h	28500	36000	

 Wavelength Classifications ( $I_F = 50\text{mA}$ ):

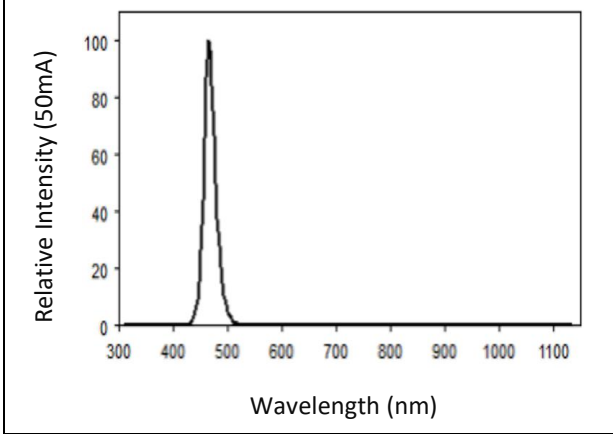
Code	Min.	Max.	Unit
S	515	517.5	nm
T	517.5	520	
U	520	522.5	
V	522.5	525	

Example Binning Information on Label:

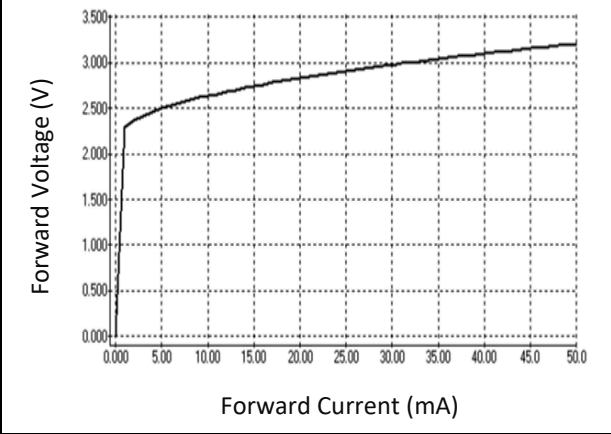
Code	V <sub>f</sub> (V)	I <sub>v</sub> (mcd)	λ <sub>d</sub> (nm)	Test Condition
ggV50	3.1~3.4	22500~28500	522.5~525	nm

**ELECTRO-OPTICAL CHARACTERISTICS:**

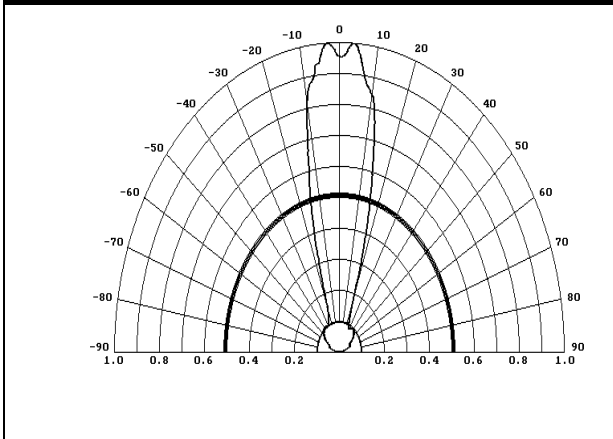
**Relative Spectral Distribution**



**Forward Current v.s. Forward Voltage**



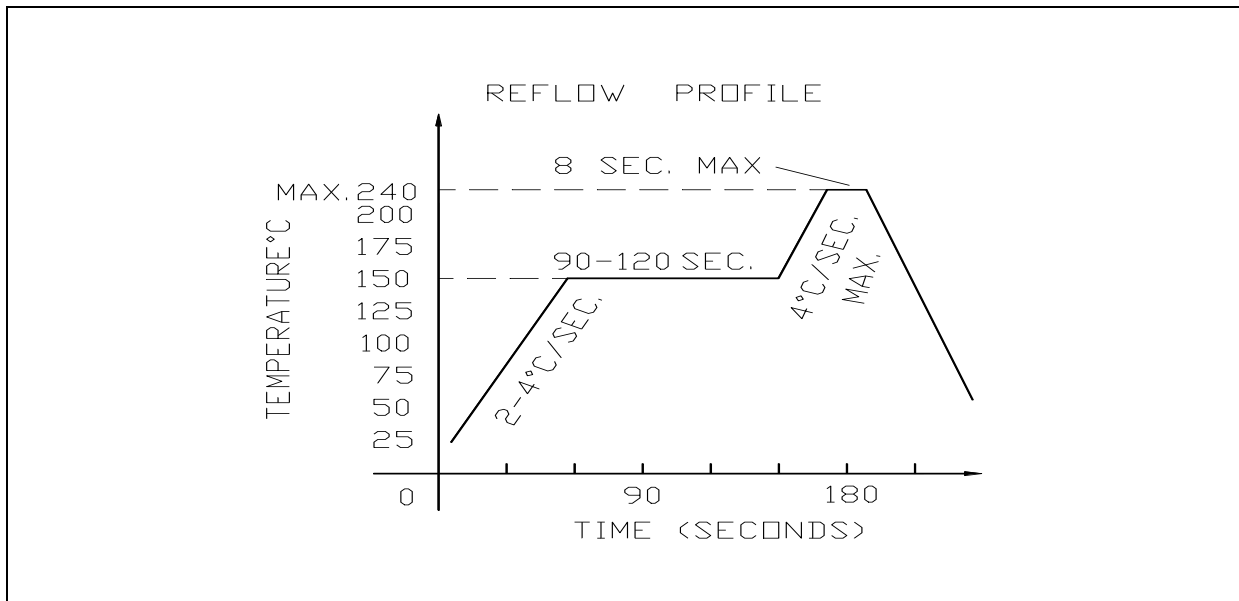
**Directive Radiation**



## RECOMMENDED SOLDERING PROFILE:

---

Lead-free Solder:

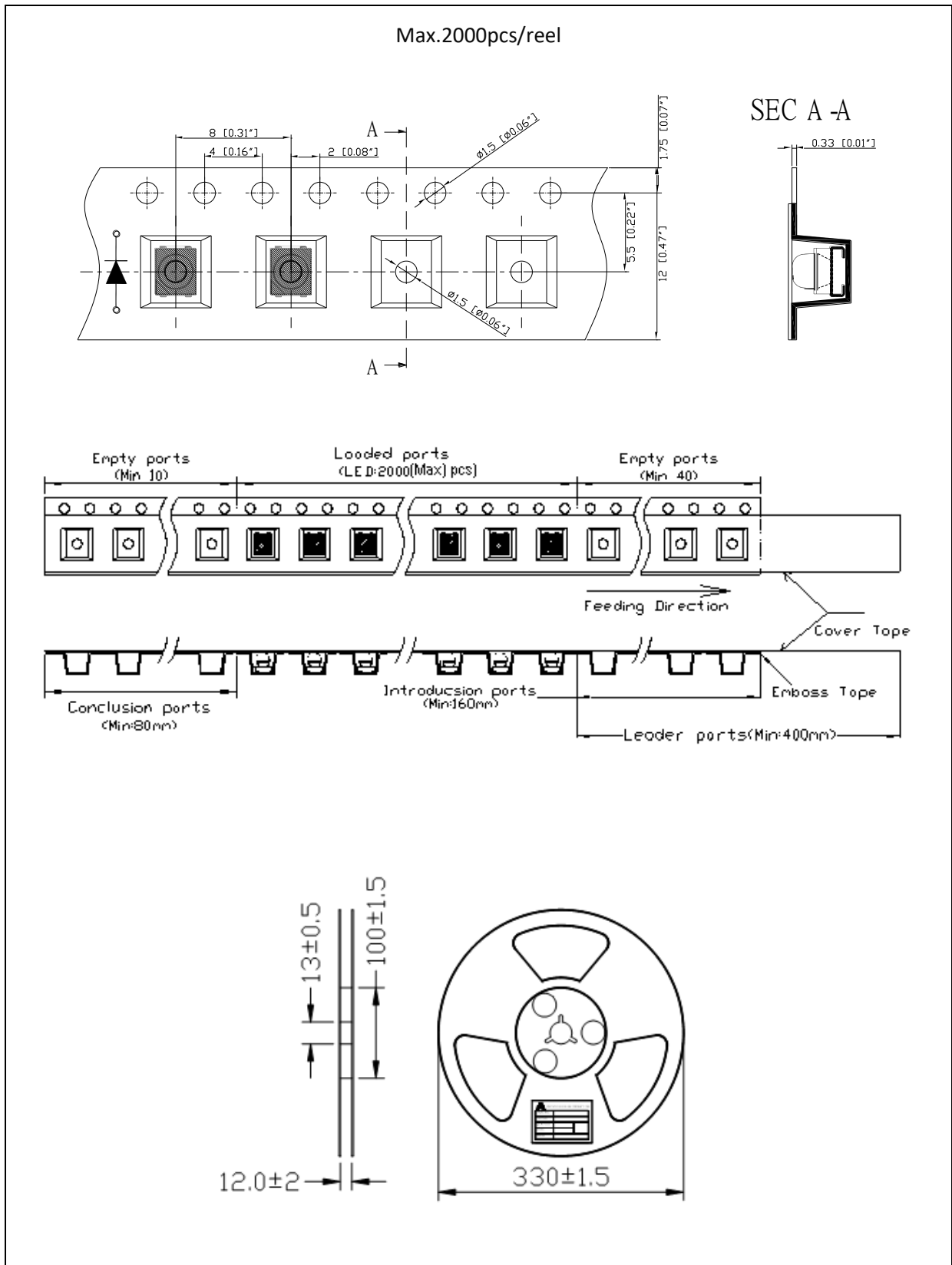


Note:

1. Maximum reflow soldering: 1 time.
2. The maximum soldering temperature is 240°C.
3. Before, during, and after soldering, should not apply stress on the components and PCB board.

**PACKING SPECIFICATION:**

Reel Dimension:



## PRECAUTIONS OF USE:

---

### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with desiccating agent <10% R.H. and apply baking before use.

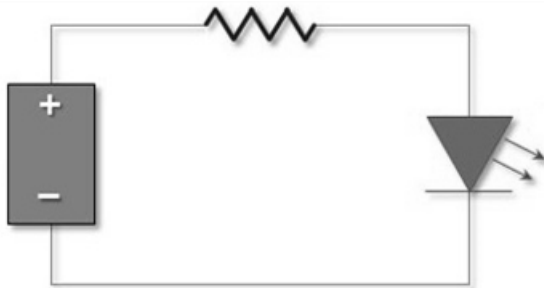
### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 60±5°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

### Testing Circuit:



Must apply resistor(s) for protection (over current proof).

### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrostatic glove is recommended when handling the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



**REVISION RECORD:**

---

Version	Date	Summary of Revision
A1.0	30/04/2020	Datasheet set-up.

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [Standard LEDs - SMD category](#):*

*Click to view products by [MGT Brightek manufacturer](#):*

Other Similar products are found below :

[LTST-C190KYKT](#) [LTST-C19GD2WT](#) [LTW-170ZDC](#) [LTW-M140SZS40](#) [LTW-M140ZVS](#) [598-8110-100F](#) [598-8610-202F](#) [91-21SUBCS400-A6TR7](#) [AAAF5060QBFSEEZGS](#) [APT1608QGW](#) [99-213/R6C-AR2T1B/2C](#) [SML-LX0606SISUGC/A](#) [SML-LXR851SIUPGUBC](#) [LT1ED53A](#) [APFA3010SURKCGKQBDC](#) [APHK1608VGCA](#) [APT2012QGW](#) [LTST-008BGEW](#) [LTW-010DCG](#) [LTW-020ZDCG](#) [LTW-21TS5](#) [LTW-220DS5](#) [598-8330-117F](#) [65-21SYGC/S530-E3/TR8](#) [CMDA20AYAA7D1S](#) [95-21SURCS530-A3TR10](#) [598-8040-100F](#) [598-8070-100F](#) [598-8140-100F](#) [598-8610-200F](#) [SML-LXR851SGSIC-TR](#) [SML-512PWT86A](#) [SMF-2432GYC-TR](#) [EASV3015RGYA0](#) [95-21UYC-S530-A5-TR7](#) [LTST-C190KFKT-5A](#) [LTST-C194TBKT-5A](#) [CLX6E-FKC-CH1M1D1BB7C3D3](#) [SML-LXL0805USBC-TR](#) [SML-LX2835SYSUGCTR](#) [LTW-M670ZVS-M5](#) [APA2106ZGC/G](#) [CLMXB-FKA-CbcfghjnpACBB79463](#) [VFA1101W-5AY3B2-TR](#) [LCB P473-P2R2-3J7L-1-Z](#) [91-21VGC/S556/S68/TR10/S370](#) [LW A67C-S2U1-FK0KM0](#) [LW A673-P1S1-FK0PM0](#) [BL-HE1G033B-TRB](#) [5988B90107F](#)